

## 54F/74F365 Hex Buffer/Driver with TRI-STATE® Outputs

#### **General Description**

The 'F365 is a hex buffer and line driver designed to be employed as a memory and address driver, clock driver and bus-oriented transmitter/receiver.

#### Features

- TRI-STATE buffer outputsOutputs sink 64 mA
- Bus-oriented

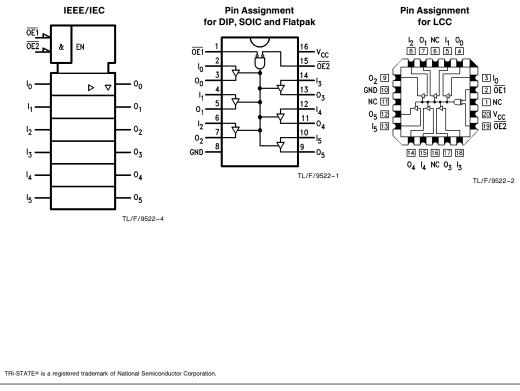
Military	Package Number	Package Description
	N16E	16-Lead (0.300" Wide) Molded Dual-In-Line
54F365DM (Note 2)	J16A	16-Lead Ceramic Dual-In-Line
	M16A	16-Lead (0.150" Wide) Molded Small Outline, JEDEC
54F365FM (Note 2)	W16A	16-Lead Cerpack
54F365LM (Note 2)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C
	54F365DM (Note 2) 54F365FM (Note 2)	Military   Number     N16E   N16E     54F365DM (Note 2)   J16A     54F365FM (Note 2)   W16A

Note 1: Devices also available in 13" reel. Use suffix = SCX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

### Logic Symbol

#### **Connection Diagrams**



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## Unit Loading/Fan Out

			54F/74F
Pin Names	Description	U.L. HIGH/LOW	Input I <sub>IH</sub> /I <sub>IL</sub> Output I <sub>OH</sub> /I <sub>OL</sub>
$\overline{OE}_1, \overline{OE}_2$	Output Enable Input (Active LOW)	1.0/0.033	20 μΑ/20 μΑ
In	Inputs	1.0/0.033	20 μA/20 μA
On	Outputs	600/106.6 (80)	-12 mA/64 mA (48 mA)

Function Table

	Inputs		Output
OE <sub>1</sub>	OE <sub>2</sub>	I	ο
L	L	L	L
L	L	н	н
х	н	х	Z
Н	х	Х	Z

#### Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias Plastic	−55°C to +175°C −55°C to +150°C
V <sub>CC</sub> Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to $+7.0V$
Input Current (Note 2)	-30 mA to $+5.0$ mA
Voltage Applied to Output in HIGH State (with $V_{CC} = 0V$ )	
Standard Output	-0.5V to V <sub>CC</sub>
TRI-STATE Output	-0.5V to +5.5V
Current Applied to Output	

# Recommended Operating Conditions

Free Air Ambient Temperature

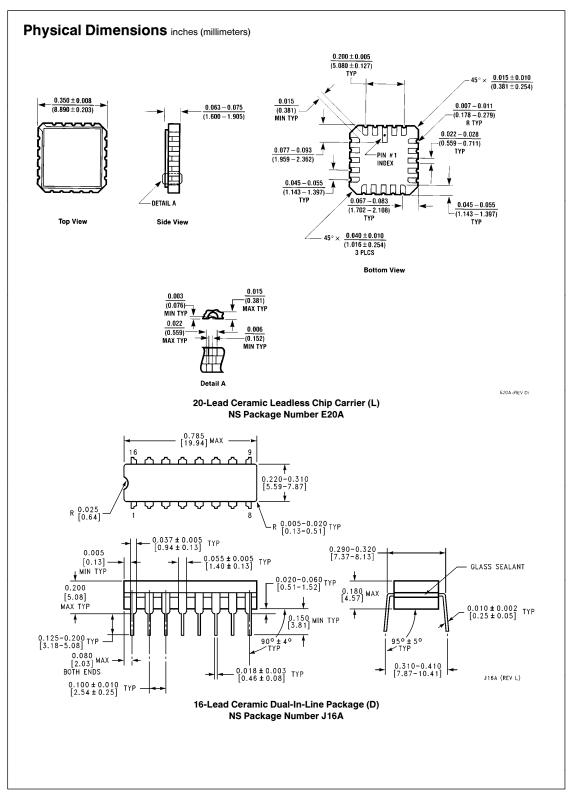
in LOW State (Max) twice the rated I<sub>OL</sub> (mA) Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

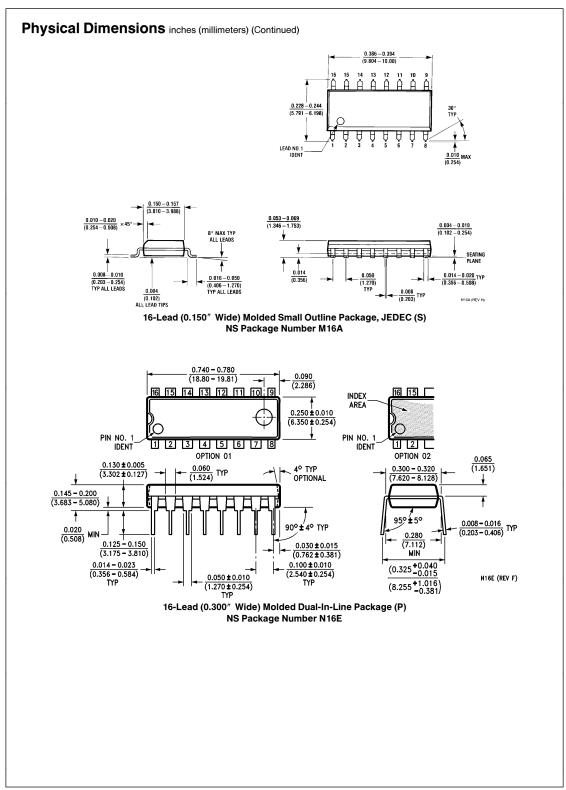
Note 2: Either voltage limit or current limit is sufficient to protect inputs.

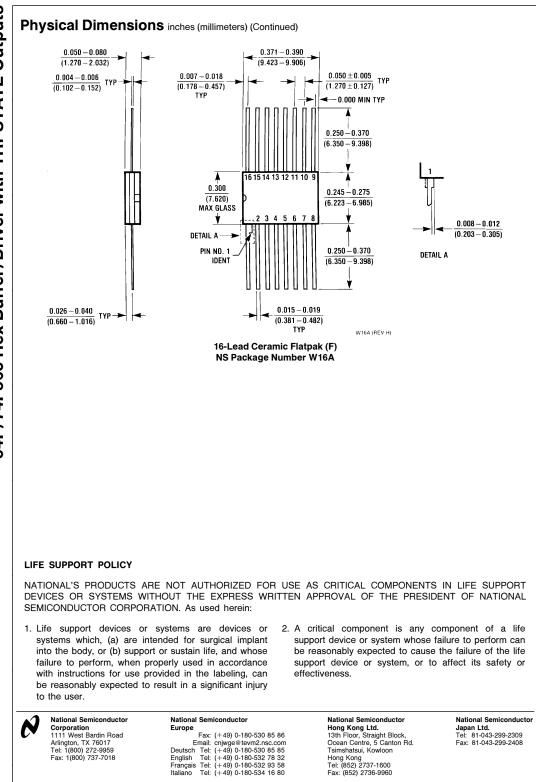
#### **DC Electrical Characteristics**

Symbol	Para	meter		54F/74F		Units	Vcc	Conditions
Symbol	Faia	ineter	Min	Тур	Max	Units	VCC	Conditions
V <sub>IH</sub>	Input HIGH Volt	age	2.0			V		Recognized as a HIGH Signa
V <sub>IL</sub>	Input LOW Volta	age			0.8	V		Recognized as a LOW Signa
V <sub>CD</sub>	Input Clamp Dio	de Voltage			-1.2	V	Min	$I_{IN} = -18 \text{ mA}$
V <sub>OH</sub>	Output HIGH Voltage	54F 10% V <sub>CC</sub> 54F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub> 74F 5% V <sub>CC</sub>	2.4 2.0 2.4 2.0 2.7			V	Min	
V <sub>OL</sub>	Output LOW Voltage	54F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub>			0.55 0.55	v	Min	$I_{OL} = 48 \text{ mA}$ $I_{OL} = 64 \text{ mA}$
I <sub>IH</sub>	Input HIGH Curr	ent			20	μA	Max	$V_{IN} = 2.7V$
I <sub>BVI</sub>	Input HIGH Curr Breakdown Tes				100	μΑ	0.0	$V_{IN} = 7.0V$
IIL	Input LOW Curre	ent			-20	μΑ	Max	$V_{IN} = 0.5V$
I <sub>OZH</sub>	Output Leakage	Current			50	μΑ	Max	$V_{OUT} = 2.7V$
I <sub>OZL</sub>	Output Leakage	Current			-50	μΑ	Max	$V_{OUT} = 0.5V$
los	Output Short-Cir	rcuit Current	-100		-225	mA	Max	$V_{OUT} = 0V$
ICEX	Output HIGH Le	akage Current			250	μΑ	Max	$V_{OUT} = V_{CC}$
I <sub>ZZ</sub>	Bus Drainage Te	est			500	μΑ	0.0V	$V_{OUT} = 5.25V$
ICCH	Power Supply C	urrent		25	35	mA	Max	V <sub>O</sub> = HIGH
I <sub>CCL</sub>	Power Supply C	urrent		44	62	mA	Max	$V_{O} = LOW$
I <sub>CCZ</sub>	Power Supply C	urrent		35	48	mA	Max	$V_{O} = HIGH Z$

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IPLH IPHLPropagation Delay In to $O_n$ 2.54.66.52.07.02.07.0IPHLIn to $O_n$ 2.54.97.02.07.02.07.5rIPZLEnable Time2.55.19.52.08.52.510.0rIPZL2.55.79.02.08.52.59.5rIPZLDisable Time2.03.66.51.56.52.07.0rIPHZDisable Time2.03.66.51.59.02.07.0rOrdering InformationTemperature Range Family 74F = Commercial 54F = Military Device Type74F365 96S 96C 20X 20Special Variations Package Code P = Plastic DIP D = Ceramic DIP F = Flatpak L = Leadless Chip Carrier (LCC)Temperature Range C = Commercial (0°C to + 70°C) M = Military (-55°C to + 125°C)	Symbol	Parameter	v	' <sub>CC</sub> = +5.0	v					Unit
In to On2.54.97.02.07.02.07.5r $PPHL$ In to On2.55.19.52.08.52.510.0 $PZL$ 2.55.79.02.08.52.59.5r $PHZ$ Disable Time2.03.66.51.56.52.07.0r $PHZ$ Disable Time2.03.66.51.56.52.07.0rOrdering InformationTemperature Range Family $74F = Commercial74F365SCXSpecial VariationsQB = Military grade device withenvironmental and burn-inprocessingX = Devices shipped in 13" reelsTemperature RangeP = Plastic DIPD = Ceramic DIPF = FlatpakL = Leadless Chip Carrier (LCC)CX$			Min	Тур	Max	Min	Max	Min	Max	
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PHZ PLZDisable Time2.03.66.51.56.52.07.0rOrdering InformationThe device number is used to form part of a simplified purchasing code where the package type and temperature range a defined as follows: $74F 365 STemperature Range FamilyTemperature Range Family74F 365 STemperature Range Family74F 365 SCCXSpecial VariationsQB = Military grade device withenvironmental and burn-inprocessingX = Devices shipped in 13" reelsTemperature RangeP = Plastic DIPD = Ceramic DIPF = FlatpakL = Leadless Chip Carrier (LCC)$		Enable Time								ns
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